

FFPF20UA60DN

20 A, 600 V, Ultrafast II Dual Diode

Features

- Ultrafast Recovery $t_{rr} = 120 \text{ ns } (@ I_F = 10 \text{ A})$
- Max Forward Voltage, $V_F = 2.3 \text{ V } (@ T_C = 25^{\circ}\text{C})$
- 600 V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- · RoHS Compliant

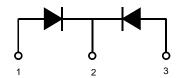
Applications

• Boost Diode in PFC and SMPS

Description

The FFPF20UA60DN is an ultrafast II dual diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applications as welder and UPS application.





1. Anode 2. Cathode 3. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

| Symbol | Parameter | Rating | Unit | |
|-----------------------------------|---|-------------|------|--|
| V _{RRM} | Peak Repetitive Reverse Voltage | 600 | V | |
| V_{RWM} | Working Peak Reverse Voltage | 600 | V | |
| V_R | DC Blocking Voltage | 600 | V | |
| I _{F(AV)} | Average Rectified Forward Current @ T _C = 25°C | 10 | Α | |
| I _{FSM} | Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave | 50 | А | |
| T _J , T _{STG} | Operating and Storage Temperature Range | -65 to +150 | °C | |

Thermal Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

| Symbol | Parameter | Max. | Unit |
|-----------------|--|------|------|
| $R_{\theta JC}$ | Maximum Thermal Resistance, Junction to Case | 6.3 | °C/W |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|--------------|--------------|---------|----------------|-----------|------------|----------|
| FFPF20UA60DN | FFPF20UA60DN | TO-220F | Tube | N/A | N/A | 50 |

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

| Symbol | Parameter | Parameter Min | | Тур. | Max. | Unit |
|---|--|---|----|----------------|------------------|---------------|
| V _{FM} 1 | I _F = 10 A I _F = 10 A | $T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 125^{\rm o}{\rm C}$ | - | 1.8 1.7 | 2.3 2.2 | V |
| I _{RM} 1 | V _R = 600 V V _R = 600 V | $T_{\rm C} = 25^{\rm o}{\rm C}$ $T_{\rm C} = 125^{\rm o}{\rm C}$ | | - | 100 500 | μΑ |
| t _{rr} I _{rr} Q _{rr} | $I_F = 10 \text{ A}, \text{ di}_F/\text{dt} = 200 \text{ A}/\mu\text{s}$ | $T_C = 25^{\circ}C$ | | 74 6 213 | 120 10 600 | ns A nC |
| W _{AVL} | Avalanche Energy (L = 40 mH) | | 10 | - | - | mJ |

Notes: 1: Pulse: Test Pulse width = $300\mu s$, Duty Cycle = 2%

Test Circuit and Waveforms

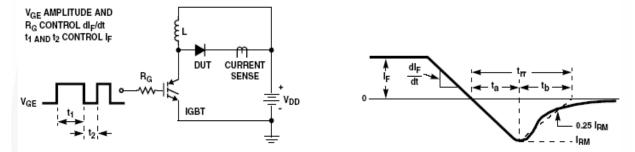


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

L = 40mH R < 0.1Ω $V_{DD} = 50V$ $\mathsf{EAVL} = 1/2\mathsf{L}12 \; [\mathsf{V}_{\mathsf{R}(\mathsf{AVL})}/(\mathsf{V}_{\mathsf{R}(\mathsf{AVL})} \cdot \mathsf{V}_{\mathsf{DD}})]$ Q1 = IGBT (BV_{CES} > DUT V_{R(AVL)}) V_{AVL} CURRENT SENSE V_{DD}

Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

Typical Performance Characteristics

Figure 3. Typical Forward Voltage Drop vs. Forward Current

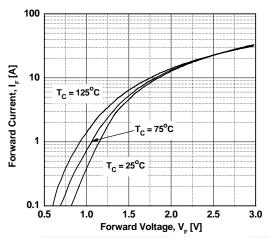


Figure 5. Typical Junction Capacitance

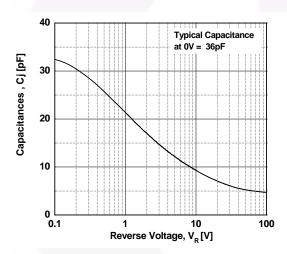


Figure 7. Typical Reverse Recovery Current vs. di_F/dt

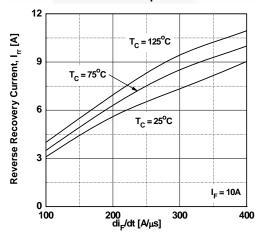


Figure 4. Typical Reverse Current vs. Reverse Voltage

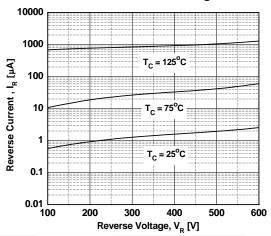


Figure 6. Typical Reverse Recovery Time vs. di_F/dt

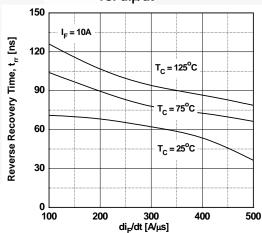
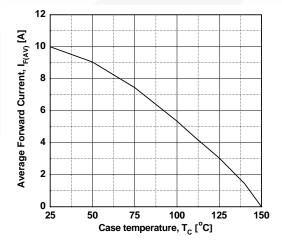


Figure 8. Forward Current Derating Curve



Package Dimensions

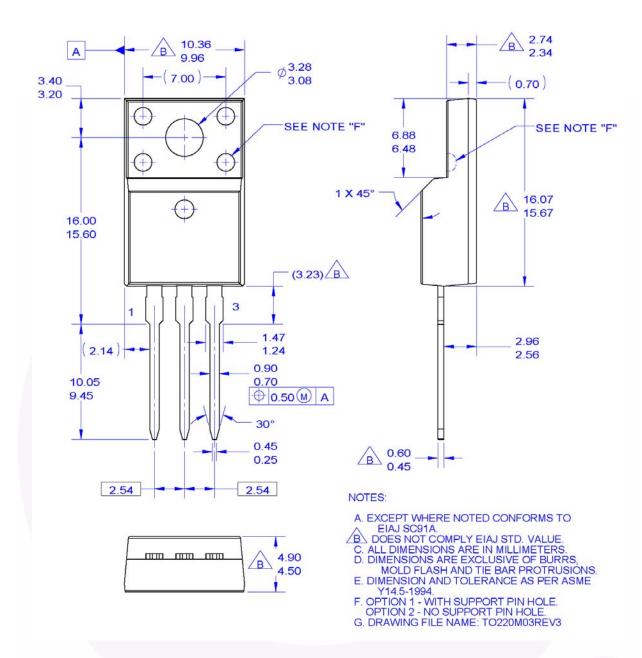


Figure 9. TO-220F 3L - TO220, MOLDED, 3LD, FULL PACK, EIAJ SC91, STRAIGHT LEAD

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